

Description

The HL101x is a photielectric couoler composed of light-emitting diode and phototransistor. It is packaged in a 4-pin LSOP 4package.

Features

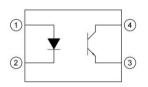
- Current transfer radio(CTR:MIN.50% at IF=5mA,VCE=5V)
- High input-output isolation voltage (Viso=5,000Vrms)
- Operating Temperature:-55°C~100°C
- RoHS
- MSL1

Applications

- Programmable controllers
- Switching power supply, intelligent meter
- Home appliances: such as air conditioners, fans,water heaters,etc







Pin Configuration

- 1 Anode
- 2 Cathode
- 3 Emitter
- 4 Collector

Rank Table Of Current Transfer Ratio (CTR=IC/IF x100%)

Rank Code	Symbol	Min	Max	Conditon
HL1010		50	600	15.5.4
HL1017	CTR	80	160	│ IF=5mA, │ VCE=5V,
HL1018		130	260	Ta=25°C
HL1019		200	400	
HL1012		63	125	IF=10mA,
HL1013	CTR	100	200	VCE=5V,
HL1014		160	320	Ta=25°C
HL1012		22		IF=1mA,
HL1013	CTR	34		VCE=5V,
HL1014		56		Ta=25°C



Absolute Ratings(Tamb = 25°C)

	Parameter	Symbol	Values	Unit
	Forward Current	I _F	50	mA
	Reverse Voltage	V _R	6	V
	Power Dissipation	Р	70	MW
Input	Peak Forward Current (100µs pulse, 100Hz)	I _{FP}	1	А
	Thermal Resistance Junction-Ambient	R _{thJ-A}	325	°C/W
	Thermal Resistance Junction-Case	R _{thJ-C}	200	°C/W
	Collector - Emitter Voltage	V _{CEO}	80	V
Output	Emitter - Collector Voltage	V _{ECO}	6	V
	Collector Current	Ic	50	mA
	Collector Power Dissipation	Pc	150	mW
Operating temperature range		T _{op}	− 55 ~ 110	°C
Storage temperature range		T _{stg}	− 55 ~ 125	°C
Total Power consumption		P(W)	200	mW
Isolation Voltage ⁽¹⁾		V _{ISO}	5000	Vrms
Soldering Temperature ⁽²⁾		T _{SOL}	260	°C

Notes:

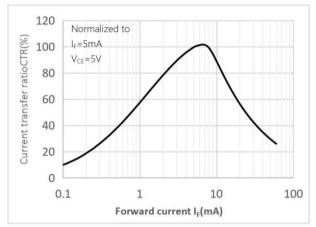
Electrical Characteristics (Ratings at 25°C)

Parameter		Symbol	Min.	Тур.	Max.	Unit	Conditon
Input	Forward Voltage	V_{F}	-	1.2	1.4	V	I _F =20mA
	Reverse Current	I_{R}	-	-	10	μΑ	V _R =4V
	Terminal Capacitance	Ct	-	30	250	pF	V=0, f=1KHz
Output	Collector Dark Current	I _{CEO}	-	-	100	nA	VCE=20V, IF=0
	Collector-Emitter Breakdown Voltage	BV _{CEO}	80			V	IC=0.1mA, IF=0
	Emitter-Collector Breakdown Voltage	BV _{ECO}	7			V	IE=10μA, IF=0
Collector-Emitter Saturation Voltage		V _{CE(sat)}			0.3	V	IF=10mA, IC=1mA
Isolation Resistance		R _{iso}	5×10 ¹⁰	1×10 ¹¹	-	Ω	DC500V, 40 ~ 60% R.H.
Floating Capacitance		Cf		0.6	1	pF	V=0, f=1MHz
Response Time (Rise)		tr			18	μs	VCE=5V, IC=5mA
Response Time (Fall)		tf			18	μs	RL=100 Ω ,

^{(1).} AC for 1 minute, R.H.= $40 \sim 60\%$ R.H. In this test, pins 1, 2 are shorted together, and pins 3, 4 are shorted together. (2). For 10 seconds

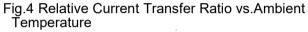
Characteristics Curves

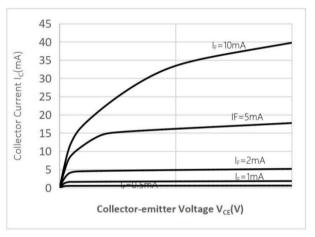
Fig.1 Relative Current Transfer Ratio vs. Forward Current Fig.2 Forward Current vs. Forward Voltage

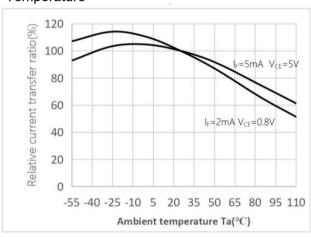


100 Forward current I_F(mA) 10 110°C 85°C 1 25°C 0.1 0.4 1.6 Forward voltage V_E(V)

Fig.3 Collector Current vs. Collector-emitter Voltage

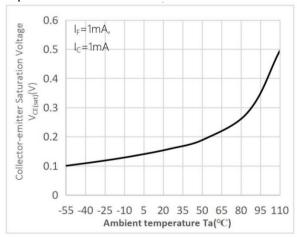






Temperature

Fig.5 Collector-emitter Saturation Voltage vs. Ambient Fig.6 Collector Dark Current vs Ambient Temperature



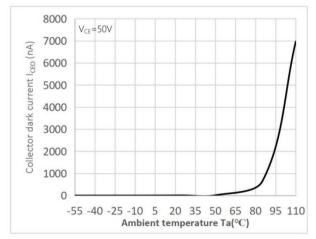


Fig.7 Response Time vs. Load Resistance

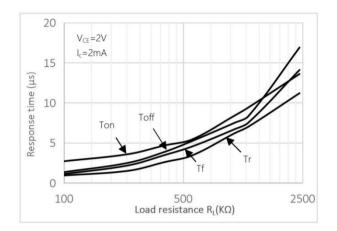


Fig.9 Collector-emitter Saturation Voltage vs Forward Current

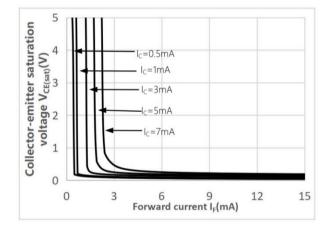


Fig.8 Frequency Response

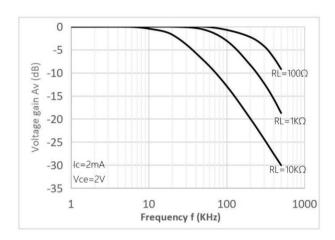
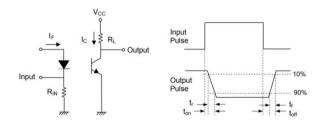
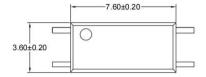


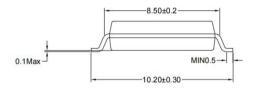
Fig.10 Switching Time Test Circuit & Waveforms

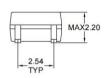




Outline Dimension



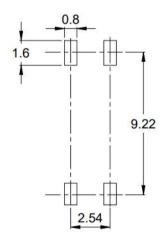




Unit: mm

Tolerance: ±0.1mm

Recommended solder pad Design



Unit: mm

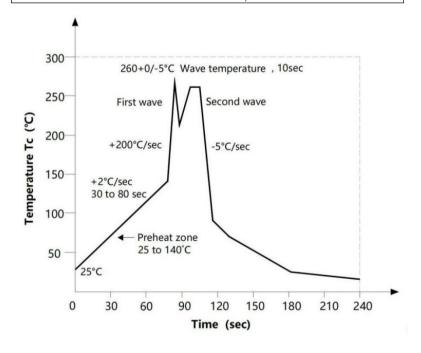
Tolerance: ±0.1mm



Temperature Profile Of Soldering

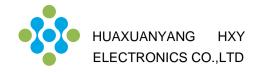
1.IR Reflow soldering (JEDEC-STD-020 compliant)

Profile item	Conditon		
Preheat -Temperature Min (TSmin) -Temperature Max (TSmax) -Time (min to max) (ts)	150°C 200°C 90±30 sec		
Soldering zone -Temperature (TL) -Time (tL)	217°C 60sec		
Peak Temperature (TP) Ramp-up rate	260°C 3°C / sec max		
Ramp-down rate	3~6°C/ sec		

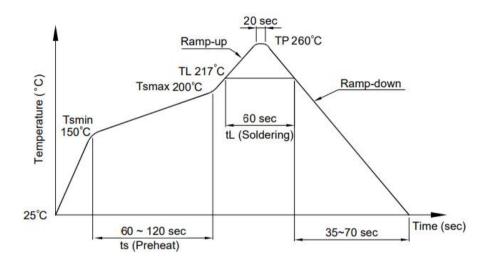


Notes:

One time soldering reflow is recommended within the condition of temperature and time profile shown below. Do not solder more than three times.



2. Wave soldering (JEDEC22A111 compliant)



3. Hand soldering by soldering iron

Allow single lead soldering in every single process. One time soldering is recommended.

Temperature: 380 +0/-5°C

Time: 3 sec max.



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